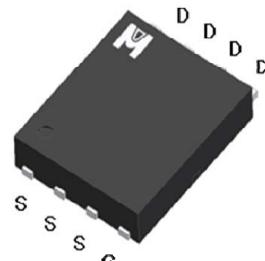
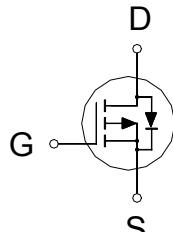


**P-Channel Logic Level Enhancement Mode Field Effect Transistor**

**Product Summary:**

BV <sub>DSS</sub>	-20V
R <sub>DSON</sub> (MAX.)	3.2mΩ
I <sub>D</sub>	-100A



UIS, R<sub>G</sub> 100% Tested

Pb-Free Lead Plating & Halogen Free



**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V <sub>GS</sub>	±12	V
Continuous Drain Current <sup>1</sup>	T <sub>C</sub> = 25 °C	I <sub>D</sub>	-100	A
	T <sub>C</sub> = 100 °C		-73	
Pulsed Drain Current <sup>2</sup>		I <sub>DM</sub>	-400	
Avalanche Current		I <sub>AS</sub>	-100	
Avalanche Energy	L = 0.1mH, ID=-100A, RG=25Ω	E <sub>AS</sub>	500	mJ
Repetitive Avalanche Energy <sup>3</sup>	L = 0.05mH	E <sub>AR</sub>	250	
Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	69	W
	T <sub>C</sub> = 100 °C		27	
Operating Junction & Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

100% UIS testing in condition of V<sub>D</sub>=-15V, L=0.1mH, V<sub>G</sub>=-5V, I<sub>L</sub>=-70A, Rated V<sub>DS</sub>=-20V P-CH

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	R <sub>θJC</sub>	1.8	50	°C / W
Junction-to-Ambient <sup>4</sup>	R <sub>θJA</sub>			

<sup>1</sup>Package Limited.

<sup>2</sup>Pulse width limited by maximum junction temperature.

<sup>3</sup>Duty cycle ≤ 1%

<sup>4</sup>50°C / W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-20			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-0.4	-0.6	-1.2	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 12V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -16V, V_{GS} = 0V$			-1	$\mu\text{A}$
		$V_{DS} = -12V, V_{GS} = 0V, T_J = 125^\circ\text{C}$			-10	
On-State Drain Current <sup>1</sup>	$I_{D(\text{ON})}$	$V_{DS} = -5V, V_{GS} = -4.5V$	-100			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(\text{ON})}$	$V_{GS} = -10V, I_D = -20\text{A}$		2.4	2.7	$\text{m}\Omega$
		$V_{GS} = -4.5V, I_D = -20\text{A}$		2.7	3.2	
		$V_{GS} = -2.5V, I_D = -20\text{A}$		3.4	4.1	
Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = -5V, I_D = -20\text{A}$		65		S
DYNAMIC						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = -10V, f = 1\text{MHz}$		11116		$\text{pF}$
Output Capacitance	$C_{oss}$			1303		
Reverse Transfer Capacitance	$C_{rss}$			592		
Gate Resistance	$R_g$	$V_{GS} = 15\text{mV}, V_{DS} = 0V, f = 1\text{MHz}$		3		$\Omega$
Total Gate Charge <sup>1,2</sup>	$Q_g(V_{GS}=-10V)$	$V_{DS} = -10V, V_{GS} = -10V, I_D = -20\text{A}$		202		$\text{nC}$
				87		
Gate-Source Charge <sup>1,2</sup>	$Q_{gs}$	$V_{DS} = -10V, V_{GS} = -10V, I_D = -20\text{A}$		18		$\text{nC}$
Gate-Drain Charge <sup>1,2</sup>	$Q_{gd}$			16		
Turn-On Delay Time <sup>1,2</sup>	$t_{d(on)}$	$V_{DS} = -10V, I_D = -1\text{A}, V_{GS} = -10V, R_{GS} = 3\Omega$		20		$\text{nS}$
Rise Time <sup>1,2</sup>	$t_r$			55		
Turn-Off Delay Time <sup>1,2</sup>	$t_{d(off)}$			270		
Fall Time <sup>1,2</sup>	$t_f$			100		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ )						
Continuous Current	$I_s$	$I_F = -20\text{A}, V_{GS} = 0V$			-100	$\text{A}$
Pulsed Current <sup>3</sup>	$I_{SM}$				-400	
Forward Voltage <sup>1</sup>	$V_{SD}$				-1.2	V
Reverse Recovery Time	$t_{rr}$			50		nS
Reverse Recovery Charge	$Q_{rr}$			180		nC

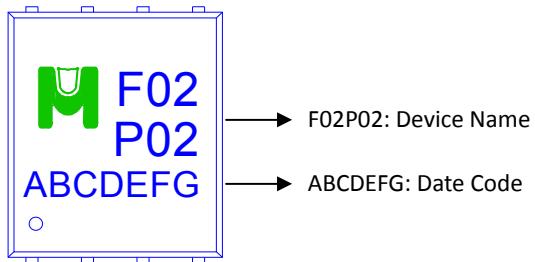
<sup>1</sup>Pulse test : Pulse Width  $\leq$  300  $\mu$ sec, Duty Cycle  $\leq$  2%.

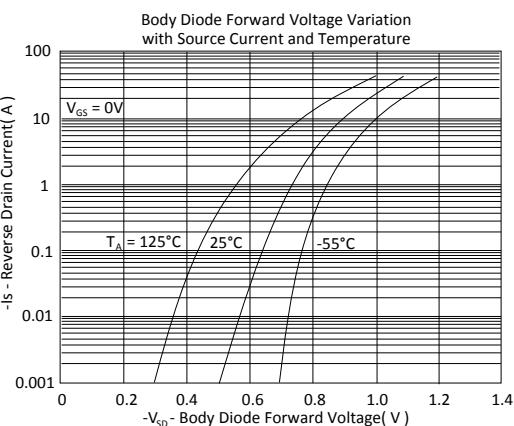
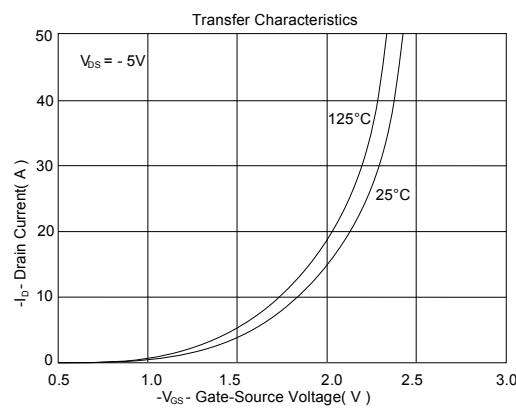
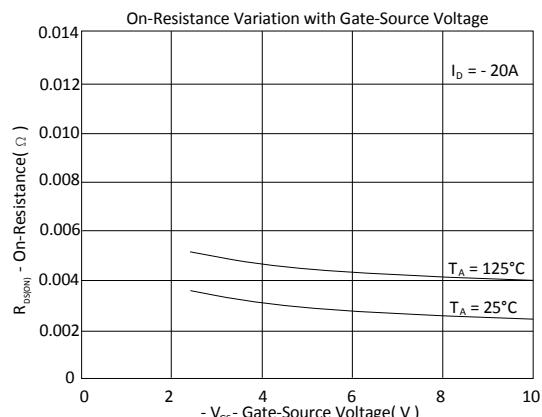
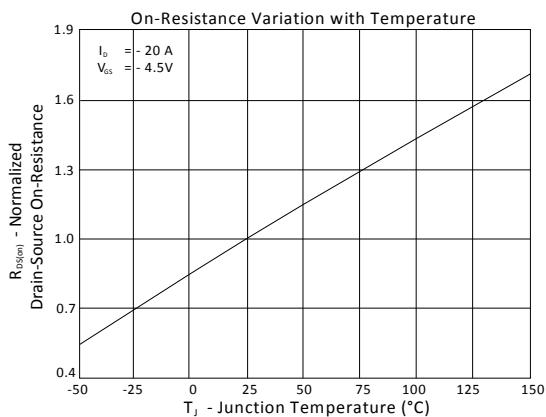
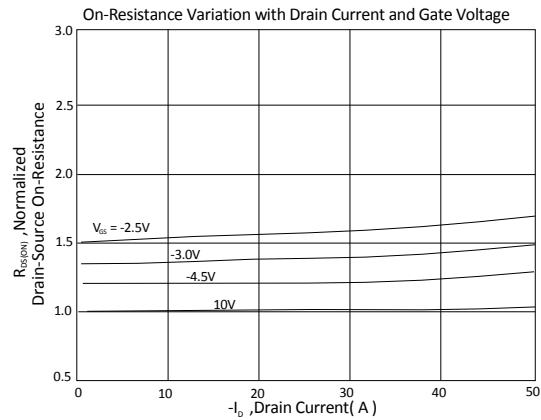
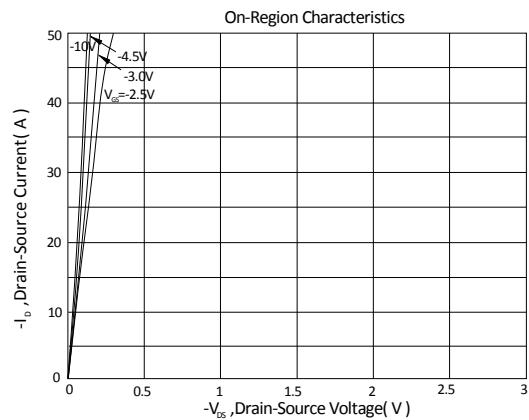
<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

**Ordering & Marking Information:**

Device Name: EMF02P02H for EDFN 5 x 6

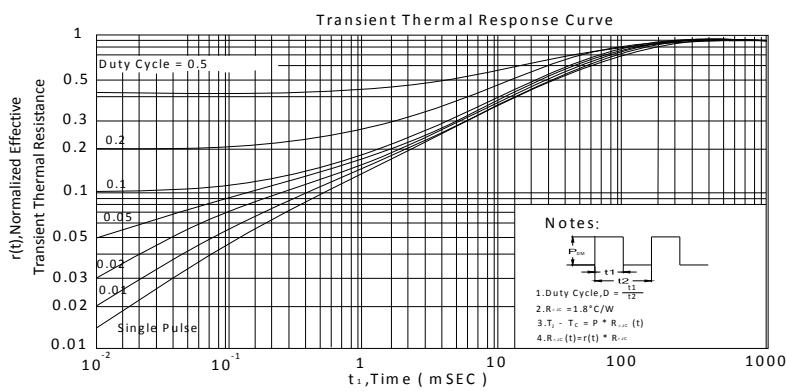
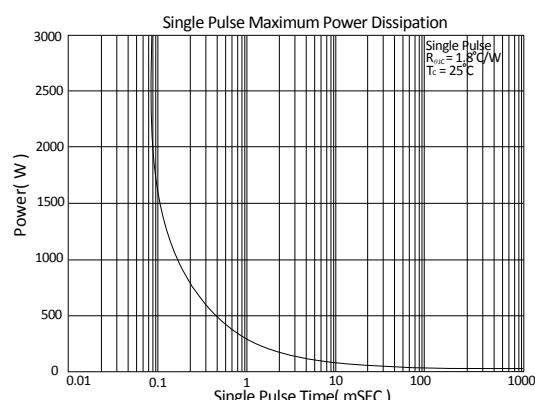
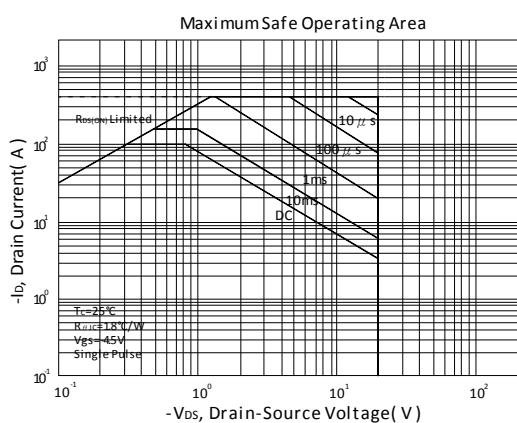
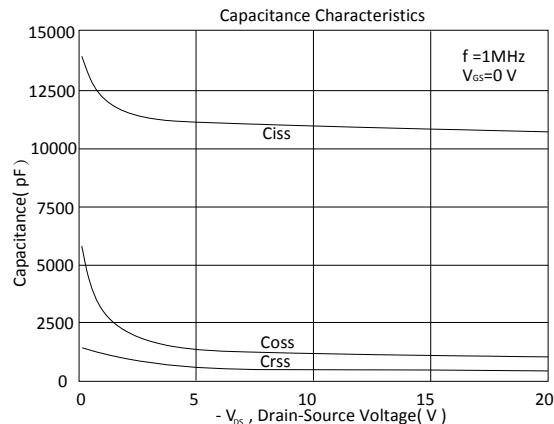
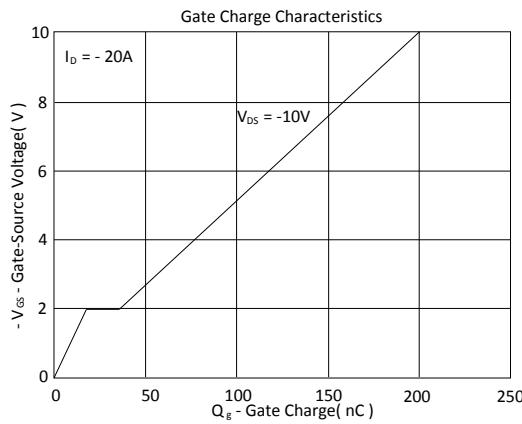






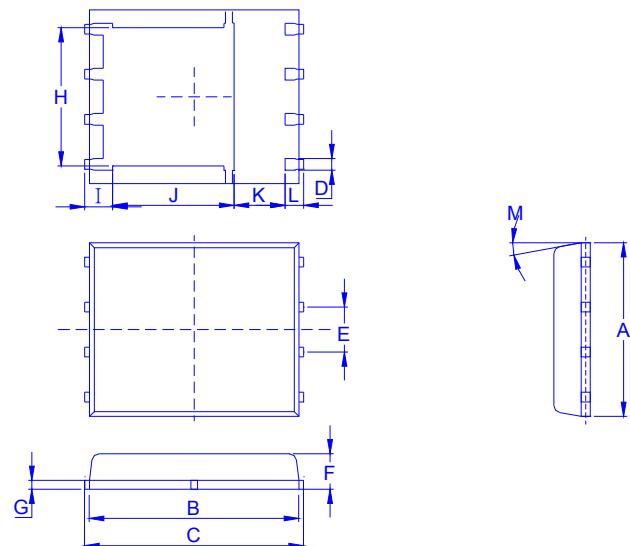
杰力科技股份有限公司  
*Excelliance MOS Corporation*

EMF02P02H





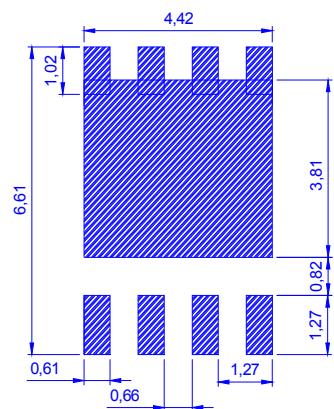
Outline Drawing



Dimension in mm

Dimension	A	B	C	D	E	F	G	H	I	J	K	L	M
Min.	4.80	5.50	5.90	0.3		0.85	0.15	3.67	0.41	3.00	0.94	0.45	0°
Typ.						1.27							
Max.	5.30	5.90	6.15	0.51		1.20	0.30	4.54	0.85	3.92	1.7	0.71	12°

Recommended minimum pads



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